

	Type	L #	Hits	Search Text	DBs	Time Stamp
1	BRS	L1	29	((156/345 or 118/715).cccls.) and splash (("3834083") or ("4113492") or ("4393807") or ("4510176") or ("4518678") or ("4576796") or ("4611553") or ("4668334") or ("4685975") or ("4732785") or ("4790262") or ("4838979") or ("4886728") or ("4899685") or ("5013586") or ("5103102") or ("5151219") or ("5238713") or ("5279926") or ("5289222") or ("5294257") or ("5358740") or ("5362608") or ("5378511") or ("5444921") or ("5474807") or ("5580607") or ("5705223") or ("6062288"))).PN.	USPAT	2001/01/19 08:27
2	IS&R	L2	29		USPAT	2001/01/19 08:40
3	BRS	L3	9	2 and (splash\$3)	USPAT	2001/01/19 08:41

Hits	Search Text	DBs	Time Stamp
3834	(156/345 or 118/715).ccls.	USPAT	2001/01/04 19:09
239	((156/345 or 118/715).ccls.) and suction\$3	USPAT	2001/01/19 08:27
63	((156/345 or 118/715).ccls.) and plunger	USPAT	2001/01/04 19:10
2338	((156/345 or 118/715).ccls.) and suction\$3) or ((156/345 or 118/715).ccls.) and (plunger or vacuum))	USPAT	2001/01/19 08:40
201787	(suction\$3 or vacuum or plung\$3) and (rotat\$3 spin\$3)	USPAT	2001/01/08 10:57
22400	((suction\$3 or vacuum or plung\$3) and (rotat\$3 spin\$3)) AND ("EDGE BEAD" OR SEMICONDUCTOR WAFER)	USPAT	2001/01/08 11:02
18224	((suction\$3 or vacuum or plung\$3) and (rotat\$3 spin\$3)) AND ("EDGE BEAD" OR SEMICONDUCTOR WAFER)) AND (RESIST ETCH\$3 COAT\$ DEPOSIT\$3)	USPAT	2001/01/08 11:05
2454	((suction\$3 or vacuum or plung\$3) and (rotat\$3 spin\$3)) AND ("EDGE BEAD" OR SEMICONDUCTOR WAFER)) AND (RESIST ETCH\$3 COAT\$ DEPOSIT\$3)) AND (156/345.CCLS. AND 427/\$.CCLS. OR 438/\$.CCLS.)	USPAT	2001/01/08 11:07
293	((156/345 or 118/715).ccls.) and suction\$3) or ((156/345 or 118/715).ccls.) and plunger)	USPAT	2001/01/08 11:11
239	((156/345 or 118/715).ccls.) and suction\$3) or ((156/345 or 118/715).ccls.) and plunger)AND (SPINNER OR "SPIN CHUCK")	USPAT	2001/01/08 11:12